

1SC0450V2B0-45 and 1SC0450V2B0-65

Preliminary Data Sheet

Single-Channel Cost-Effective SCALE™-2 IGBT Driver Core with Fiber-Optic Interface for 4500V and 6500V IGBTs

Abstract

The 1SC0450V2B0-xx features versatile fiber-optic links and drives all usual high-power IGBT modules up to 4500V or 6500V. Thanks to its high output power capability, a single 1SC0450V2B0-xx driver can drive up to four parallel-connected 4500V or 6500V IGBT modules and consequently provides easy inverter design covering higher power ratings. Multi-level topologies involving 3300V or 4500V IGBTs with higher isolation requirements can also be easily supported by 1SC0450V2B0-xx.

The 1SC0450V2B0-xx combines a complete single-channel driver core with all components required for driving, such as an isolated DC/DC converter, short-circuit protection, Advanced Active Clamping as well as supply voltage monitoring. Enhanced features such as gate boosting are also implemented and provide further driving benefits.

The driver's secondary side is electrically isolated from its primary side. The 1SC0450V2B0-45 meets the requirements of 4500V IGBT applications while the 1SC0450V2B0-65 covers the requirements of 6500V IGBT applications.

An output current of 50A and 6W drive power is available, making the 1SC0450V2B0-xx an ideal driver platform for universal use in medium and high-power applications. The driver provides a gate voltage swing of 15V/-10V. The turn-on voltage is regulated to maintain a stable 15V regardless of the output power level.

Its outstanding EMC allows safe and reliable operation even in harsh industrial applications.

Product Highlights

- ✓ Ultra-compact single-channel driver
- ✓ Highly integrated SCALE™-2 chipset
- ✓ Gate current $\pm 50\text{A}$, 6W output power
- ✓ 15V/-10V gate driving
- ✓ Blocking voltages up to 4500V or 6500V
- ✓ Basic isolation to IEC 61800-5-1 and IEC 60664-1
- ✓ Short signal propagation delays
- ✓ UL-compliant
- ✓ Lead-free

Applications

- ✓ Traction
- ✓ Railroad power supplies
- ✓ Light rail vehicles
- ✓ HVDC
- ✓ Flexible AC transmission systems (FACTS)
- ✓ Medium-voltage converters
- ✓ Wind-power converters
- ✓ Industrial drives
- ✓ Medical applications

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Safety Notice!

The data contained in this data sheet is intended exclusively for technically trained staff. Handling all high-voltage equipment involves risk to life. Strict compliance with the respective safety regulations is mandatory!

Any handling of electronic devices is subject to the general specifications for protecting electrostatic-sensitive devices according to international standard IEC 60747-1, Chapter IX or European standard EN 100015 (i.e. the workplace, tools, etc. must comply with these standards). Otherwise, this product may be damaged.

Important Product Documentation

This data sheet contains only product-specific data. For a detailed description, must-read application notes and important information that apply to this product, please refer to "1SC0450V2B0 Description & Application Manual" on www.power.com/igbt-driver/go/1SC0450.

Mechanical Dimensions

Dimensions: Refer to the "1SC0450V2B0 Description & Application Manual"

Fiber-Optic Interfaces

Interface	Remarks	Part type #
Drive signal input IN	Fiber-optic receiver (Notes 1, 2)	HFBR-2522ETZ
Status output OUT	Fiber-optic transmitter (Notes 1, 3)	HFBR-1522ETZ

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Absolute Maximum Ratings

Parameter	Remarks	Min	Max	Unit
Supply voltage V_{DC}	VDC to GND	0	16	V
Supply voltage V_{CC}	VCC to GND	0	16	V
Logic output voltage V_{SO}	SO to GND	-0.5	$V_{CC}+0.5$	V
SO current	Failure condition, total current (Note 27)		20	mA
Gate peak current \hat{I}_G	Note 4	-50	+50	A
External gate resistance	Turn-on and turn-off (Notes 4, 5)	0.3		Ω
Average supply current I_{DC}	Notes 6, 7		860	mA
Output power	Ambient temperature $\leq 70^\circ\text{C}$ (Notes 8, 9)		8	W
	Ambient temperature $\leq 85^\circ\text{C}$ (Note 8)		6	W
Gate boosting output power	Notes 8, 10		4	W
Gate charge Q_{GBS}	GBS to GH		15	nC
Bias current I_{GBS}	On-state		20	μA
Switching frequency f			10	kHz
Test voltage (50Hz/1min.)	Primary to secondary (Note 19)		10.2	kV_{eff}
$ dV/dt $	Rate of change of input to output voltage		35	$\text{kV}/\mu\text{s}$
Operating voltage	Primary/secondary, 1SC0450V2B0-45		4500	V_{peak}
	Primary/secondary, 1SC0450V2B0-65		6500	V_{peak}
Operating temperature	Notes 9	-40	+85	$^\circ\text{C}$
Storage temperature		-40	+85	$^\circ\text{C}$

Recommended Operating Conditions

Power Supply	Remarks	Min	Typ	Max	Unit
Supply voltage V_{DC}	VDC to GND	14.5	15	15.5	V
Supply voltage V_{CC}	VCC to GND	14.5	15	15.5	V

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Electrical Characteristics

All data refer to +25°C and $V_{CC} = V_{DC} = 15V$ unless otherwise specified.

Power Supply	Remarks	Min	Typ	Max	Unit
Supply current I_{DC}	Without load		107		mA
Supply current I_{CC}			20		mA
Coupling capacitance C_{io}	Primary to output, total		8		pF
Supply voltage VGB	VGB to VISO (Note 23)		25		V
VGB charge	VGB to VISO (Note 24)		540		nC
Power Supply Monitoring	Remarks	Min	Typ	Max	Unit
Supply threshold V_{CC}	Primary side, clear fault	11.6	12.6	13.6	V
	Primary side, set fault (Note 16)	11.0	12.0	13.0	V
Monitoring hysteresis	Primary side, set/clear fault	0.35			V
Supply threshold $V_{ISO}-V_E$	Secondary side, clear fault	11.6	12.6	13.6	V
	Secondary side, set fault (Note 17)	11.0	12.0	13.0	V
Monitoring hysteresis	Secondary side, set/clear fault	0.35			V
Supply threshold V_E-V_{COM}	Secondary side, clear fault		5.15		V
	Secondary side, set fault (Note 17)		4.85		V
Monitoring hysteresis	Secondary side, set/clear fault		0.3		V
Power Supply Protection	Remarks	Min	Typ	Max	Unit
Not implemented					
Logic Outputs	Remarks	Min	Typ	Max	Unit
SO pull-up resistor to VCC	On board		10		kΩ
SO output voltage V_{SO}	Failure condition, $I(SO) < 6.5mA$			0.7	V
GBS voltage	GBS to GH, on-state (Note 23)		9		V
	GBS to GH, off-state (Note 23)		0		V
Short-Circuit Protection	Remarks	Min	Typ	Max	Unit
V_{CE} -monitoring threshold	Factory set value (Note 21)		10.2		V
Minimum response time	Note 14		5.1		μs
Delay to clear fault state $T_{d(cfs)}$	After IGBT short circuit (Note 15)		8		μs
Delay in IGBT turn-off T_{cshd}	Factory-set value (Note 22)		0.2		μs

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Timing Characteristics	Remarks	Min	Typ	Max	Unit
Turn-on delay $T_{d(on)}$	Note 11		135		ns
Turn-off delay $T_{d(off)}$	Note 11		105		ns
Output rise time $T_{r(GH)}$	Note 12		30		ns
Output fall time $T_{f(GL)}$	Note 12		25		ns
Transmission delay of fault state	Note 18		150		ns
Acknowledge delay time $T_{d(ack)}$	Note 25		220		ns
Acknowledge pulse width $T_{(ack)}$	On host side	400	700	1050	ns

Electrical Isolation	Remarks	Min	Typ	Max	Unit
Test voltage (50Hz/1s)	Primary to secondary side (Note 19)	10.2			kV _{eff}
Partial discharge extinction volt.	Primary to secondary side				
	1SC0450V2B0-45 (Note 20)	5400			V _{peak}
	1SC0450V2B0-65 (Note 20)	7800			V _{peak}
Creepage distance (Note 26)					
On the PCB	Primary to secondary side (Material group IIIa)	45			mm
On the transformer	Primary to secondary side (Material group I)	36			mm
Clearance distance	Primary to secondary side	25			mm

Output	Remarks	Min	Typ	Max	Unit
Blocking capacitance	VISO to VE (Note 13)		18.8		μF
	VE to COM (Note 13)		9.4		μF

Output Voltage Swing

The output voltage swing consists of two distinct segments. First, there is the turn-on voltage V_{GH} between pins GH and VE. V_{GH} is regulated and maintained at a constant level for all output power values and frequencies.

The second segment of the output voltage swing is the turn-off voltage V_{GL} . V_{GL} is measured between pins GL and VE. It is a negative voltage. It changes with the output power to accommodate the inevitable voltage drop across the internal DC/DC converter.

Output Voltage	Remarks	Min	Typ	Max	Unit
Turn-on voltage, V_{GH}	Any load condition		15.0		V
Turn-off voltage, V_{GL}	No load		-9.5		V
Turn-off voltage, V_{GL}	6W output power		-9.0		V
Turn-off voltage, V_{GL}	8W output power		-8.8		V

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Footnotes to the Key Data

- 1) The transceivers required on the host controller side are not supplied with the gate driver. It is recommended to use the same types as used in the gate driver. For product information, refer to www.power.com/igbt-driver/go/fiberoptics.
- 2) The recommended transmitter current at the host controller is 20mA. A higher current may increase jitter or delay at turn-off.
- 3) The typical transmitter current at the gate driver is 20.5mA. In case of supply undervoltage, the minimum transmitter current at the gate driver is 15mA: this is suitable for adequate plastic optical fibers with a length of up to 10 meters.
- 4) The maximum peak gate current refers to the highest current level occurring during the product lifetime. It is an absolute value and also applies to short pulses.
- 5) Twice the given minimum resistance value must be inserted between the interface connectors GH and GL. Moreover, the given minimal resistance value must be used in the full gate turn-on (interface connector GH to gate) and turn-off (interface connector GL to gate) path.
- 6) The average supply input current is limited for thermal reasons. Higher values than specified by the absolute maximum rating are permissible (e.g. during power supply start up) if the average remains below the given value, provided this average is taken over a time period which is shorter than the thermal time constants of the driver in the application.
- 7) There is no means of actively controlling or limiting the input current in the driver. In the case of start-up with very high blocking capacitor values, or in case of short circuit at the output, the supply input current has to be limited externally.
- 8) The maximum output power must not be exceeded at any time during operation. It must also be observed for time periods shorter than the thermal time constants of the driver in the application.
- 9) An extended output power range is specified in the output power section for ambient temperatures limited from -40°C to 70°C.
- 10) The gate-boosting output power can be calculated according to "1SC0450V2B0 Description & Application Manual" and is specified as a part of the gate driver's total output power, which is the sum of the turn-on power over the output GH plus the gate-boosting power over the output VGB. The turn-on power approximately equals the turn-off power of the output GL. The gate boosting is not active at turn-off.
- 11) Including the delay of the external fiber-optic links (cable length: 1m). Measured from the transition of the turn-on or turn-off command at the optical transmitter on the host controller side to the direct output of the gate drive unit (excluding the delay of the gate resistors). The delay time is measured between 50% of the input signal and the 10% voltage swing of the corresponding output. The delay time is independent of the output loading.
- 12) Output rise and fall times are measured between 10% and 90% of the nominal output swing with an output load of 4.7Ω and 270nF. These values are given for the driver side of the gate resistors. The time constant of the output load in conjunction with the present gate resistors leads to an additional delay at the load side of the gate resistors.
- 13) External blocking capacitors should be placed between the VISO and VE as well as the VE and COM terminals. Refer to "1SC0450V2B0 Description & Application Manual" (paragraph "DC/DC output (VISO), emitter (VE) and COM terminals)" for recommendations. Ceramic capacitors are recommended.
- 14) The minimum response time is valid for the circuit given in the description and application manual with the values of the corresponding tables.
- 15) Measured on the host side. The fault status on the secondary side is extended by the "delay in IGBT turn-off" and automatically reset after the specified time. Refer to "1SC0450V2B0 Description & Application Manual" for more details.
- 16) Undervoltage monitoring of the primary-side supply voltage (VCC to GND). If the voltage drops below this limit, a fault is transmitted to the SO output.
- 17) Undervoltage monitoring of the secondary-side supply voltage (VISO to VE and VE to COM, which correspond to the approximate turn-on and turn-off gate-emitter voltages). If the corresponding voltage drops below this limit, a fault is transmitted to the fiber-optic output and the IGBT is switched off after the corresponding delay. Refer to "1SC0450V2B0 Description & Application Manual" for more

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- details.
- 18) Delay of external fiber-optic links. Measured from the driver secondary side (ASIC output) to the optical receiver on the host controller with a 1m cable.
 - 19) HiPot testing (= dielectric testing) must generally be restricted to suitable components. This gate driver is suited for HiPot testing. Nevertheless, it is strongly recommended to limit the testing time to 1s slots. Excessive HiPot testing at voltages much higher than 3182V_{AC,rms} with 1SC0450V2B0-45 and 4596V_{AC,rms} with 1SC0450V2B0-65 may lead to insulation degradation. No degradation has been observed over 1min. testing at 10.2kV_{AC,rms}. Every production sample (transformer only) shipped to customers has undergone 100% testing at the given value for 1s.
 - 20) Partial discharge measurements are performed in accordance with IEC 60270 and IEC 60664-1 for basic insulation requirements.
 - 21) The V_{CE}-monitoring threshold value can be reduced with an external resistor. Refer to "1SC0450V2B0 Description & Application Manual".
 - 22) The turn-off event of the IGBT after a secondary-side fault (IGBT short circuit or undervoltage monitoring) can be additionally delayed with an external capacitor. Refer to "1SC0450V2B0 Description & Application Manual".
 - 23) The voltage values of the pins VGB resp. GBS are correspondingly about 50V and 34V respectively referred to COM. This must be considered for the design of the creepage and clearance distances.
 - 24) The given value applies for a full discharge of VGB to VISO at turn-on, when no external capacitor is used. It can be increased by using additional external capacitors.
 - 25) Including the delay of the external fiber-optic links (cable length: 1m). Measured from the transition of the turn-on or turn-off command at the optical transmitter on the host controller side to the transition of the acknowledge signal at the optical receiver on the host controller side.
 - 26) Creepage distances over additional components (e. g. fiber-optic wires, fixation screws, ...) which are not part of the driver must be taken into account by the user.
 - 27) Including current flowing into the on-board pull-up resistor of 10kΩ.

RoHS Statement

On the basis of Annexes II and III of European Directive 2011/65/EC of 08 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (RoHS), we hereby state that the products described in this datasheet do not contain lead (Pb), mercury (Hg), hexavalent chromium (Cr VI), cadmium (Cd), polibrometo of biphenyl (PBB) or polibrometo diphenyl ether (PBDE) in concentrations exceeding the restrictions set forth in Annex II of 2011/65/EC with due consideration of the applicable exemptions as listed in Annex III of 2011/65/EC.

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Ordering Information

Our international terms and conditions of sale apply.

Type Designation	Description
1SC0450V2B0-45	Single-channel SCALE-2 driver core for 4500V IGBTs
1SC0450V2B0-65	Single-channel SCALE-2 driver core for 6500V IGBTs

Product home page: www.power.com/igbt-driver/go/1SC0450

Refer to www.power.com/igbt-driver/go/nomenclature for information on driver nomenclature.

Information about Other Products

For other drivers, product documentation, and application support:

Please click: www.power.com

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